

## P-Ch 60V Fast Switching MOSFETs



## Features

- Split Gate Trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$

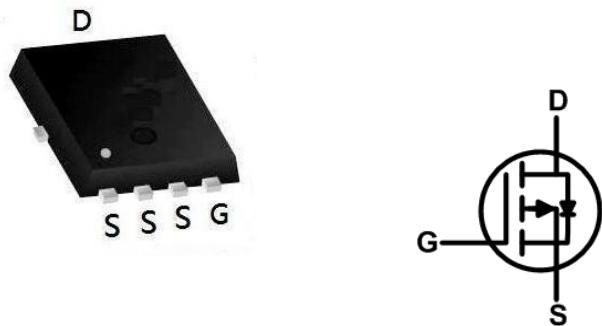
## Product Summary

BVDSS	RDS(on)	ID
-60V	42mΩ	-20A

## Applications

- DC-DC Converters
- Power management functions
- Synchronous-rectification applications

## PDFN5060-8L Pin Configuration



## Absolute Maximum Ratings:

Symbol	Parameter		Value	Units
$V_{DSS}$	Drain-to-Source Voltage		-60	V
$I_D$	Continuous Drain Current	$T_C=25^\circ\text{C}$	-20	A
	Continuous Drain Current	$T_C=100^\circ\text{C}$	-12	A
$I_{DM}^{a1}$	Pulsed Drain Current		-100	A
$V_{GS}$	Gate-to-Source Voltage		$\pm 20$	V
$P_D$	Power Dissipation		38	W
$E_{AS}^{a2}$	Single pulse avalanche energy		48	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range		150, -55 to 150	°C
$T_L$	Maximum Temperature for Soldering		260	°C

## Thermal Characteristics:

Symbol	Parameter	Value	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	3.12	°C/W

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Electrical Characteristic ( $T_A = 25^\circ\text{C}$ , unless otherwise specified):

## Static Characteristics

Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
$V_{DSS}$	Drain to Source Breakdown Voltage	$V_{GS}=0\text{V}$ , $I_D=-250\mu\text{A}$	-60	--	--	V
$I_{DSS}$	Drain to Source Leakage Current	$V_{DS}=-60\text{V}$ , $V_{GS}=0\text{V}$	--	--	1.0	$\mu\text{A}$
$I_{GSS(F)}$	Gate to Source Forward Leakage	$V_{GS}=-20\text{V}$ , $V_{DS}=0\text{V}$	--	--	100	nA
$I_{GSS(R)}$	Gate to Source Reverse Leakage	$V_{GS}=+20\text{V}$ , $V_{DS}=0\text{V}$	--	--	-100	nA
$V_{GS(\text{TH})}$	Gate Threshold Voltage	$V_{DS}=V_{GS}$ , $I_D=-250\mu\text{A}$	-1.3	-1.8	-2.3	V
$R_{DS(\text{ON})1}$	Drain-to-Source On-Resistance	$V_{GS}=-10\text{V}$ , $I_D=-10\text{A}$	--	42	51	$\text{m}\Omega$
$R_{DS(\text{ON})2}$	Drain-to-Source On-Resistance	$V_{GS}=-4.5\text{V}$ , $I_D=-5.0\text{A}$	--	52	65	$\text{m}\Omega$

## Dynamic Characteristics

Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
$C_{iss}$	Input Capacitance	$V_{GS} = 0\text{V}$ $V_{DS} = -30\text{V}$ $f = 1.0\text{MHz}$	--	667	--	pF
$C_{oss}$	Output Capacitance		--	114	--	
$C_{rss}$	Reverse Transfer Capacitance		--	5.2	--	
$R_G$	Gate resistance	$V_{GS}=0\text{V}, V_{DS}$ Open	--	5.0	--	$\Omega$

## Resistive Switching Characteristics

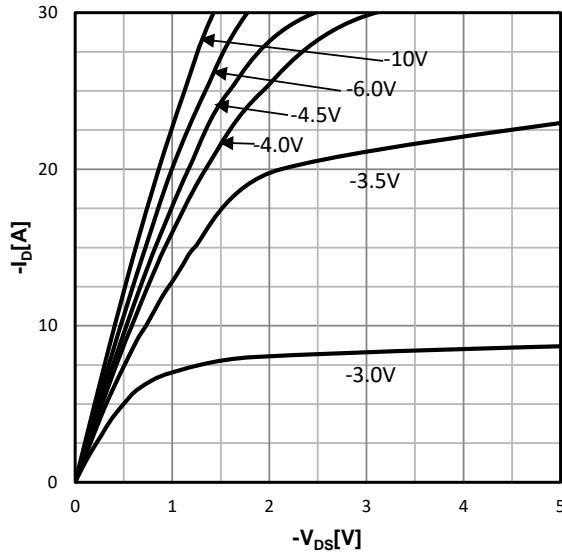
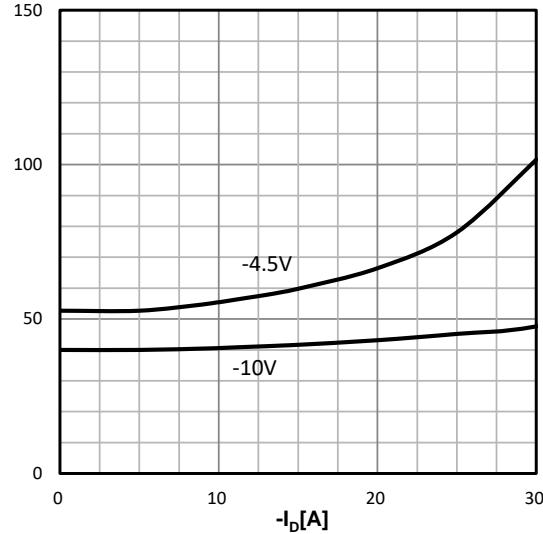
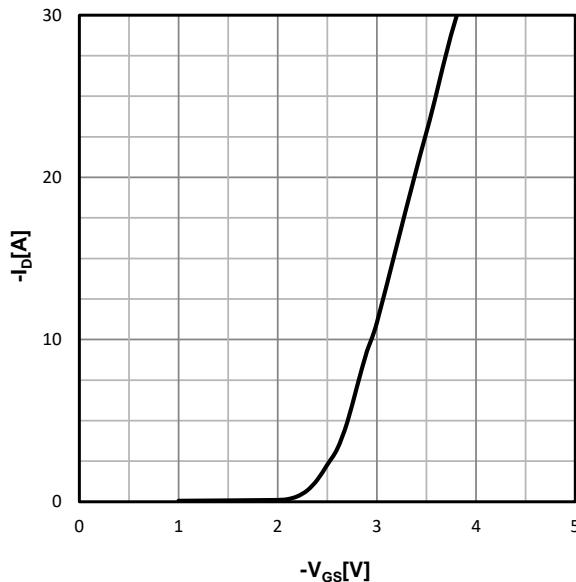
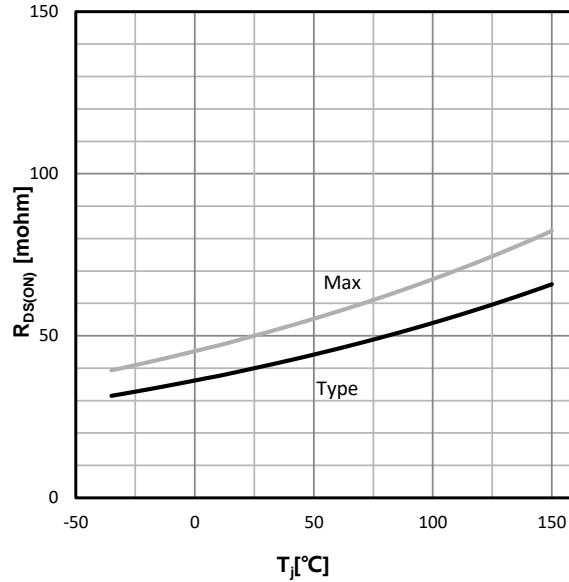
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
$t_{d(\text{ON})}$	Turn-on Delay Time	$I_D = -10\text{A}$ $V_{DS} = -30\text{V}$ $V_{GS} = -10\text{V}$ $R_G = 3\Omega$	--	10	--	ns
$t_r$	Rise Time		--	6	--	
$t_{d(\text{OFF})}$	Turn-Off Delay Time		--	40	--	
$t_f$	Fall Time		--	13	--	
$Q_g$	Total Gate Charge	$V_{GS} = -10\text{V}$ $V_{DS} = -30\text{V}$ $I_D = -10\text{A}$	--	11.6	--	nC
$Q_{gs}$	Gate Source Charge		--	2.4	--	
$Q_{gd}$	Gate Drain Charge		--	1.5	--	

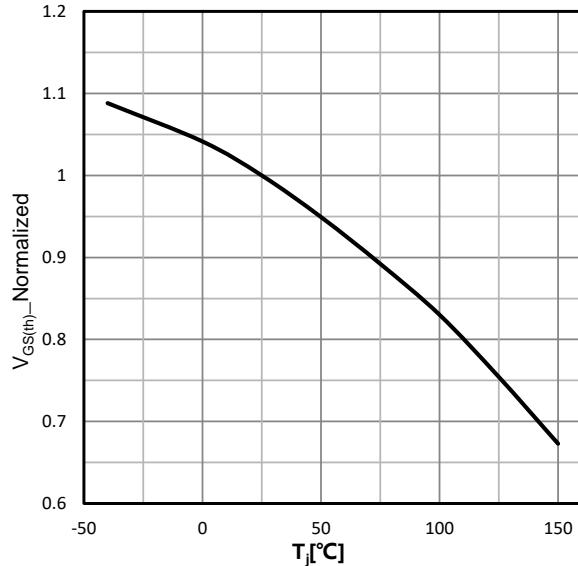
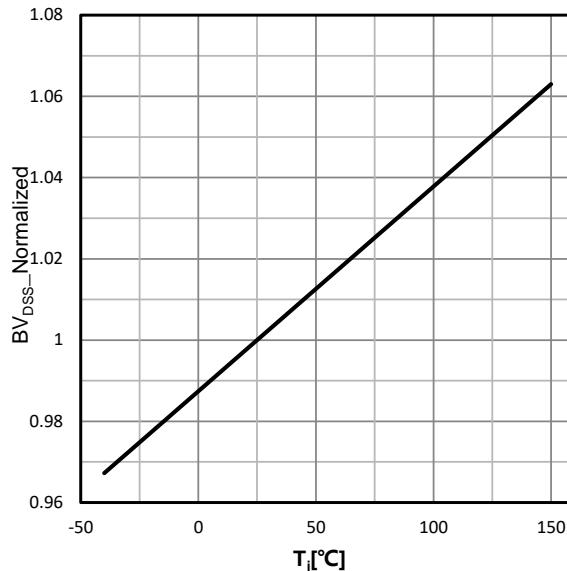
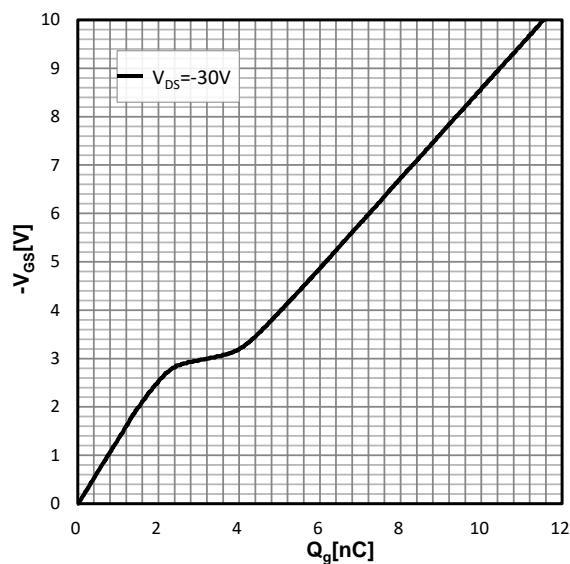
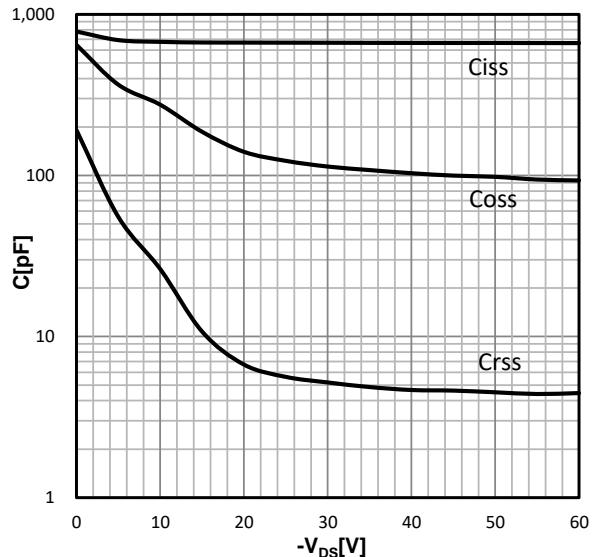
## Source-Drain Diode Characteristics

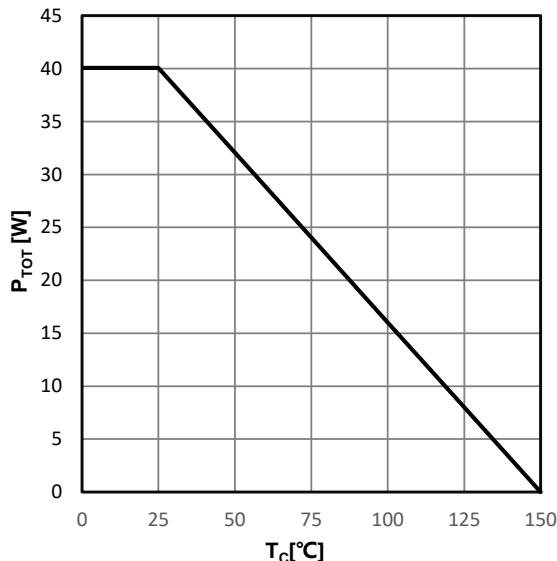
Symbol	Parameter	Test Conditions	Value			Units
			Min.	Typ.	Max.	
$I_s$	Diode Forward Current	$T_c = 25^\circ\text{C}$	--	--	-20	A
$I_{SM}$	Diode Pulse Current		--	--	-100	A
$V_{SD}$	Diode Forward Voltage	$I_s = -10\text{A}$ , $V_{GS} = 0\text{V}$	--	--	-1.2	V
$t_{rr}$	Reverse Recovery time	$I_s = -10\text{A}$ , $V_{DD} = -30\text{V}$ , $dI/dt = 100\text{A}/\mu\text{s}$	--	28	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	40	--	nC

a1: Repetitive rating; pulse width limited by maximum junction temperature

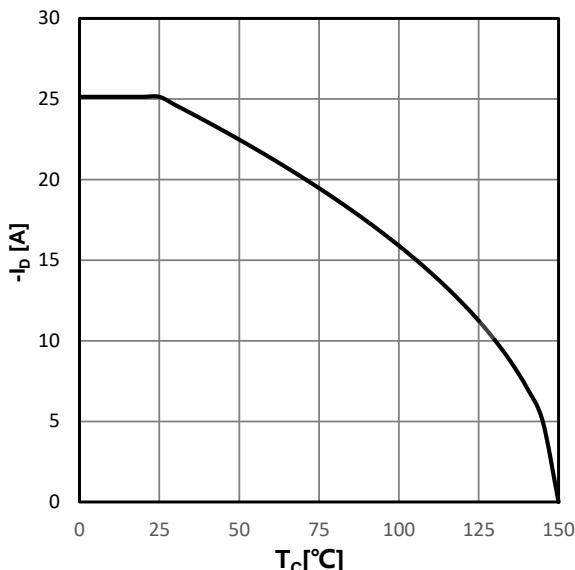
a2:  $V_{DD} = -30\text{V}$ ,  $L = 0.3\text{mH}$ ,  $R_G = 25\Omega$ , Starting  $T_j = 25^\circ\text{C}$

**General Description:****Figure 1: Typ. output characteristics**
 $I_D=f(V_{DS})$ ,  $T_j=25\text{ }^\circ\text{C}$ ; parameter:  $V_{GS}$ **Figure 2: Typ. drain-source on resistance**
 $R_{DS(on)}=f(I_D)$ ,  $T_j=25\text{ }^\circ\text{C}$ ; parameter:  $V_{GS}$ **Figure 3: Typ. transfer characteristics**
 $I_D=f(V_{GS})$ ,  $|V_{DS}|>2|I_D|R_{DS(on)}\max$ ;**Figure 4: drain-source on resistance**
 $R_{DS(on)}=f(T_j)$ ,  $I_D=-10A$ ,  $V_{GS}=-10V$ ;

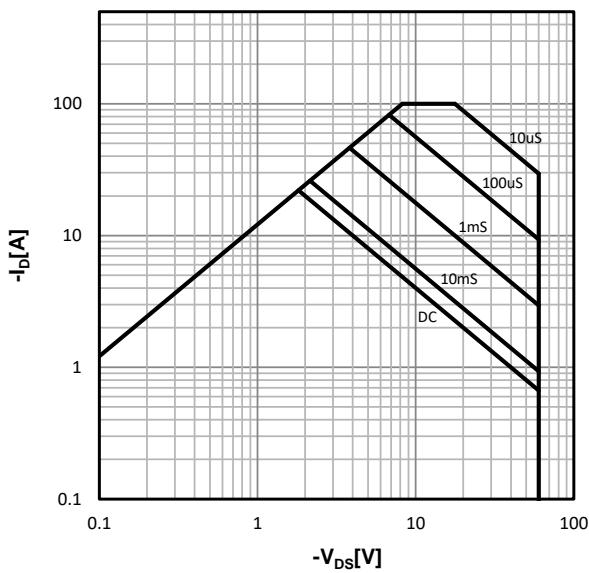
**Figure 5: Typ. gate threshold voltage** $V_{GS} = f(T_j)$ ,  $V_{GS} = V_{DS}$ ,  $I_D = -250\mu A$ ;**Figure 6: Drain-source breakdown voltage** $V_{BR(DSS)} = f(T_j)$ ;  $I_D = -250\mu A$ ;**Figure 7: Typ. gate charge** $V_{GS} = f(Q_g)$ ,  $I_D = -10A$ ,  $T_j = 25$  °C; parameter:  $V_{DS}$ **Figure 8: Typ. Capacitances** $C = f(V_{DS})$ ;  $V_{GS} = 0V$ ;  $f = 1.0$  MHz;

**Figure 9: Power dissipation**

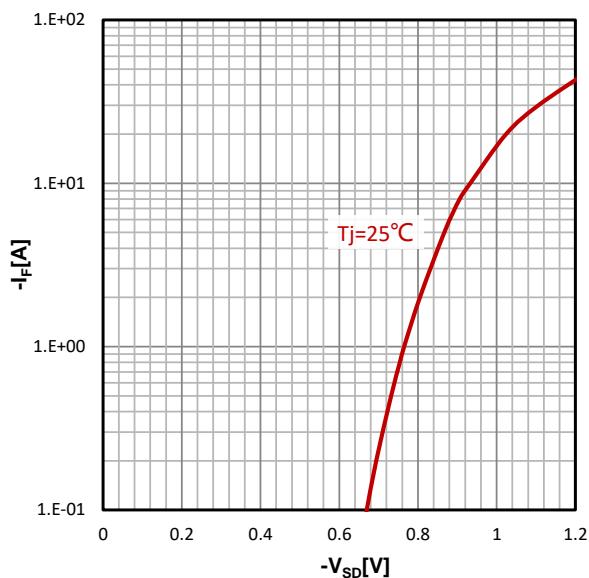
$$P_{tot}=f(T_C);$$

**Figure 10: Drain current**

$$I_D=f(T_C);$$

**Figure 11: Safe operating area**

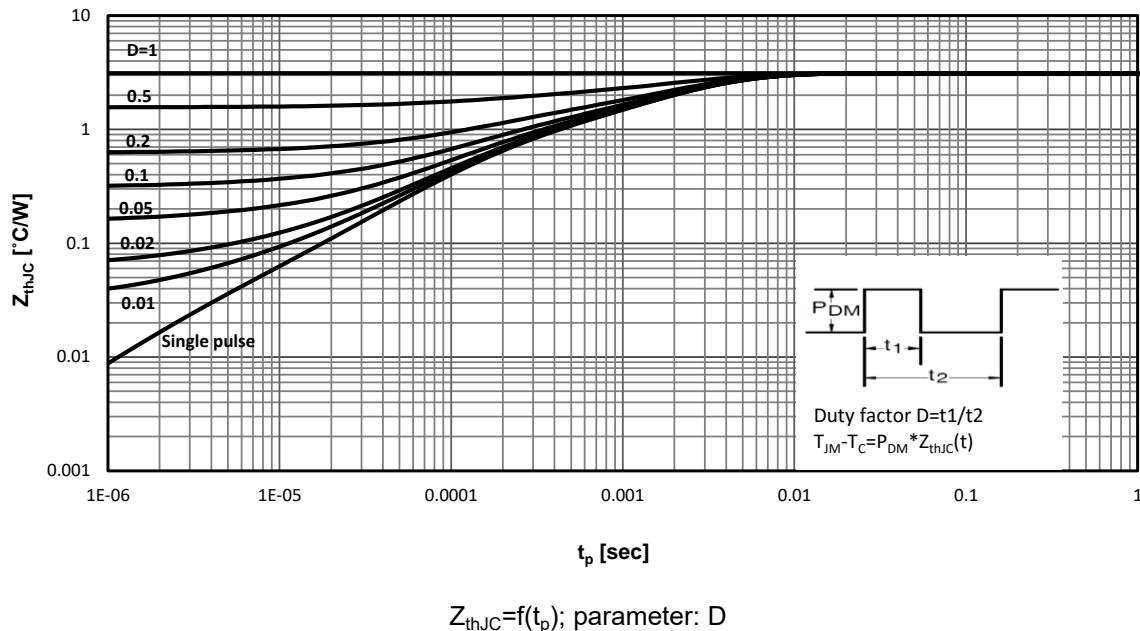
$$I_D=f(V_{DS}); \quad T_C=25 \text{ } ^\circ\text{C}; \quad D=0; \quad \text{parameter: tp}$$

**Figure 12: Typ. forward characteristics**

$$I_F=f(V_{SD});$$

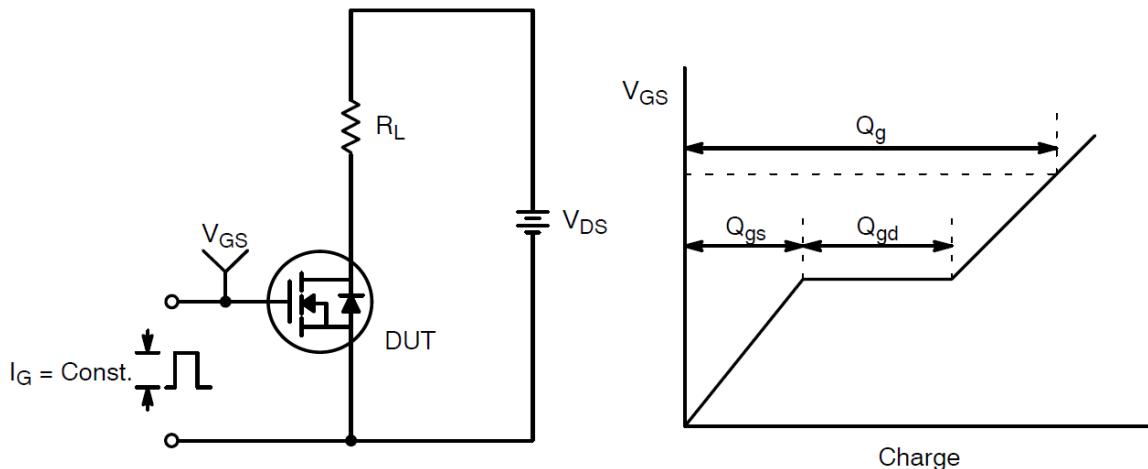
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Figure 13: Max. Transient Thermal Impedance

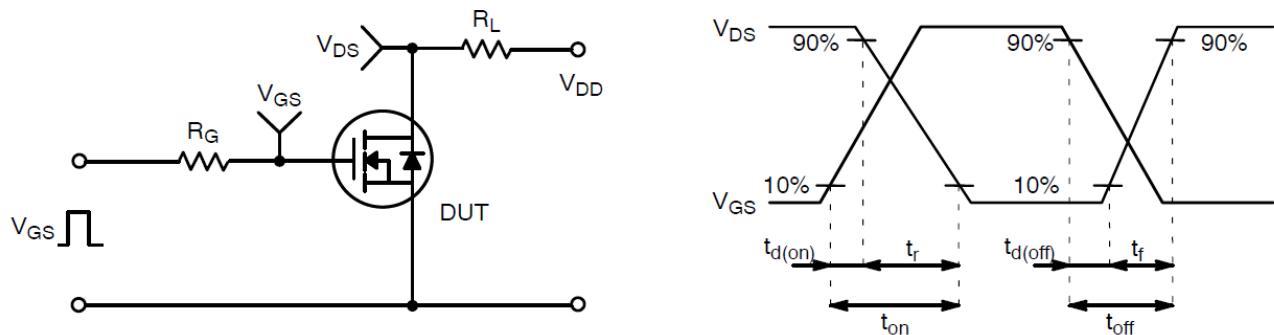


$$Z_{thJC}=f(t_p); \text{ parameter: } D$$

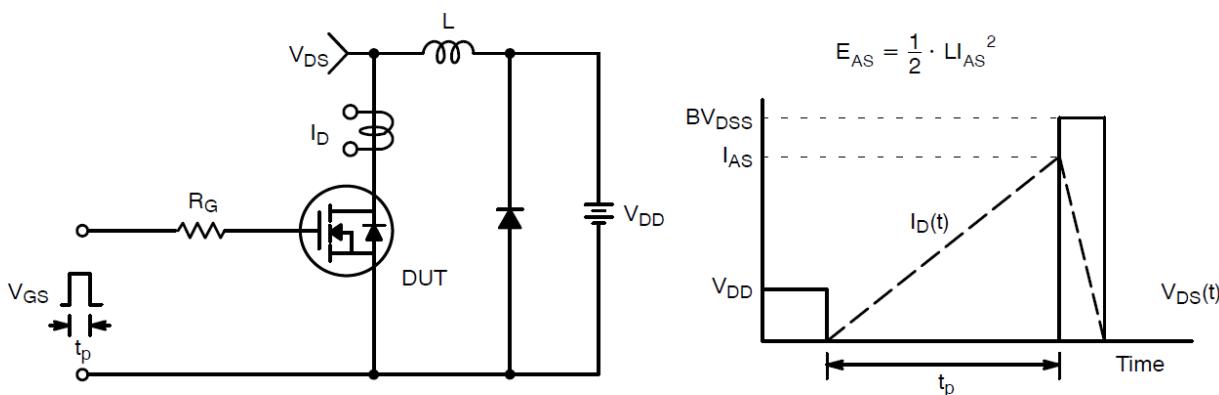
## Test Circuit and Waveform:



Gate Charge Test Circuit & Waveform

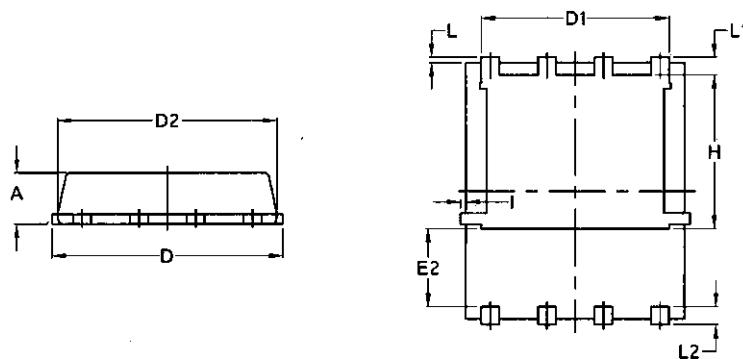
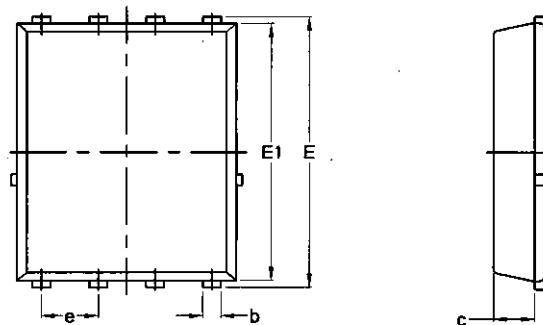


Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

## Package Mechanical Data-PDFN5060-8L-Single



Symbol	Common			
	mm		Inch	
	Min	Max	Min	Max
A	1.03	1.17	0.0406	0.0461
b	0.34	0.48	0.0134	0.0189
c	0.824	0.0970	0.0324	0.082
D	4.80	5.40	0.1890	0.2126
D1	4.11	4.31	0.1618	0.1697
D2	4.80	5.00	0.1890	0.1969
E	5.95	6.15	0.2343	0.2421
E1	5.65	5.85	0.2224	0.2303
E2	1.60	/	0.0630	/
e	1.27 BSC		0.05 BSC	
L	0.05	0.25	0.0020	0.0098
L1	0.38	0.50	0.0150	0.0197
L2	0.38	0.50	0.0150	0.0197
H	3.30	3.50	0.1299	0.1378
I	/	0.18	/	0.0070